

BR860-1 Pro

LED Display Control Board



Specifications

Change History

Document Version	Release Date	Description
V1.1.0	2026-09-04	- Added certification. - Added the leakage current.
V1.0.5	2026-05-07	- Updated the appearance diagram. - Updated the net weight information.
V1.0.4	2026-04-17	Updated the maximum load capacity.
V1.0.3	2025-12-30	- Updated features. - Updated the pin diagram and pin definition. - Updated the appearance diagram.
V1.0.2	2025-10-10	Updated the appearance diagram.
V1.0.1	2025-09-04	- Updated the output voltage. - Updated the dimensions diagram.
V1.0.0	2024-11-27	First release

Introduction

The BR860-1 Pro is an LED display control board developed by NovaStar Tech Co., Ltd. (hereinafter referred to as NovaStar). It integrates a power module converts 90V to 264V alternating current into direct current, which directly powers the screen modules. Furthermore, the product offers functions such as undervoltage, overvoltage, overcurrent, overpower, and short circuit protection, ensuring safety, high efficiency, and good reliability.

For PWM driver ICs, the maximum load capacity per board is:

- 512×512@60Hz (For 8bit video sources)
- 512×256@60Hz (For 10bit and 12bit video sources)



Note

For PWM driver ICs, the maximum load capacity per card when used with COEX controllers is:

- 512×512@60Hz (For 10 bit video sources)
- 512×256@60Hz (For 12 bit video sources)

Certifications

RoHS

If the product lacks the certifications required for sale in the destination country or region, please contact NovaStar promptly for confirmation or assistance. Otherwise, the customer shall bear any resulting legal risks and liabilities, and NovaStar reserves the right to seek compensation.

Features

- Power Module and Receiving Card in One Package

The product supports input voltage of 90 Vac to 264 Vac and converts it to DC to directly power the modules. Furthermore, the product offers functions such as undervoltage, overvoltage, overcurrent, overpower, and short-circuit protection.

- Multi-layer Grayscale Calibration

Work with NovaStar's high-precision calibration system to generate unique calibration coefficients for low-grayscale image parts to ensure their uniformity while supporting the traditional brightness and chroma calibration.

- LED Image Booster (Effects depend on driver IC)

- Color Management: Support standard (Rec.709 / DCI-P3 / Rec.2020) and custom color gamuts, enabling more precise colors on the screen.
- Precise Grayscale: Individually correct the 65,536 levels of grayscale (16bit) of the driver IC to fix the display problems at low grayscale conditions, such as low-grayscale brightness spikes, brightness dips, color cast and mottling. This function can also better assist other display technologies, such as 22bit+ and individual gamma adjustment for RGB, allowing for a smoother and more uniform image.
- 22bit+: Improve the LED screen grayscale by 64 times to avoid grayscale loss due to low brightness and allow for a smoother image with more details in dark areas.

- Thermal Compensation 2.0

Work with NovaStar's high-precision calibration system to precisely collect the thermal distribution data of LED cabinets and generate unique thermal compensation data for each pixel, effectively eliminating cabinet- or module-level cyan or red cross-hatch patterns caused by uneven thermal distribution.

- HDR

- Support HDR10 and comply with the SMPTE ST 2084 and SMPTE ST 2086 standards.
- Support HLG.
- Pixel Level Brightness and Chroma Calibration

Work with NovaStar's calibration system to calibrate the brightness and chroma of each pixel, effectively eliminating differences and enabling high consistency for both brightness and chroma.
- Quick Adjustment of Dark or Bright Lines

The different brightness of seams caused by splicing of modules or cabinets can be corrected to improve the visual experience. The correction is easy and takes effect immediately.
- Multi-batch Adjustment

Adjust the brightness and chroma of cabinets or modules to minimize display discrepancies caused by variations in production batches.
- Low Latency

Low Latency is enabled by default. For PWM driver ICs, the latency of the video source at the receiving card end can be reduced to 1 frame. To use low latency with DCLK continuous PWM driver ICs, a customized firmware is required.
- 3D

Work with the controller that supports 3D function to enable 3D output.
- Individual Gamma Adjustment for RGB

Working with NovaLCT and the controller that supports this function, the receiving card supports individual adjustment to red gamma, green gamma and blue gamma, which can effectively control image non-uniformity at low grayscale conditions and white balance offset, allowing for a more realistic image.
- 90° Image Rotation

The display image can be rotated in multiples of 90° (0°/90°/180°/270°).
- One-Click Sleep

Paired with NovaLCT for power management, enabling energy-saving with one simple click.
- Module Flash Management

For modules with flash memory, the information stored can be managed, allowing for the storage and readback of calibration coefficients and module IDs.
- Mapping 1.1

The cabinet displays the Ethernet port, receiving card, and controller numbers in different colors, clearly showing the physical locations and connection topology of receiving cards.

- Settings of a Stored Image in the Receiving Card

The image displayed during startup, or displayed when the Ethernet cable is disconnected or there is no video signal.

- Temperature and Voltage Monitoring

Real-time monitoring of the temperature and voltage of the receiving card, without the need for other external devices.

- Bit Error Detection

Monitor the number of erroneous packets in the Ethernet data transmission of the receiving card to help troubleshoot network communication problems.

- Firmware Program Readback

The receiving card firmware program can be read back and saved to the local computer.

- Configuration Parameter Readback

The receiving card configuration parameters can be read back and saved to the local computer.

- Loop Backup

The receiving card and controller form a loop via the primary and backup line connections. When a fault occurs at a location of the lines, the screen can still display the image normally.

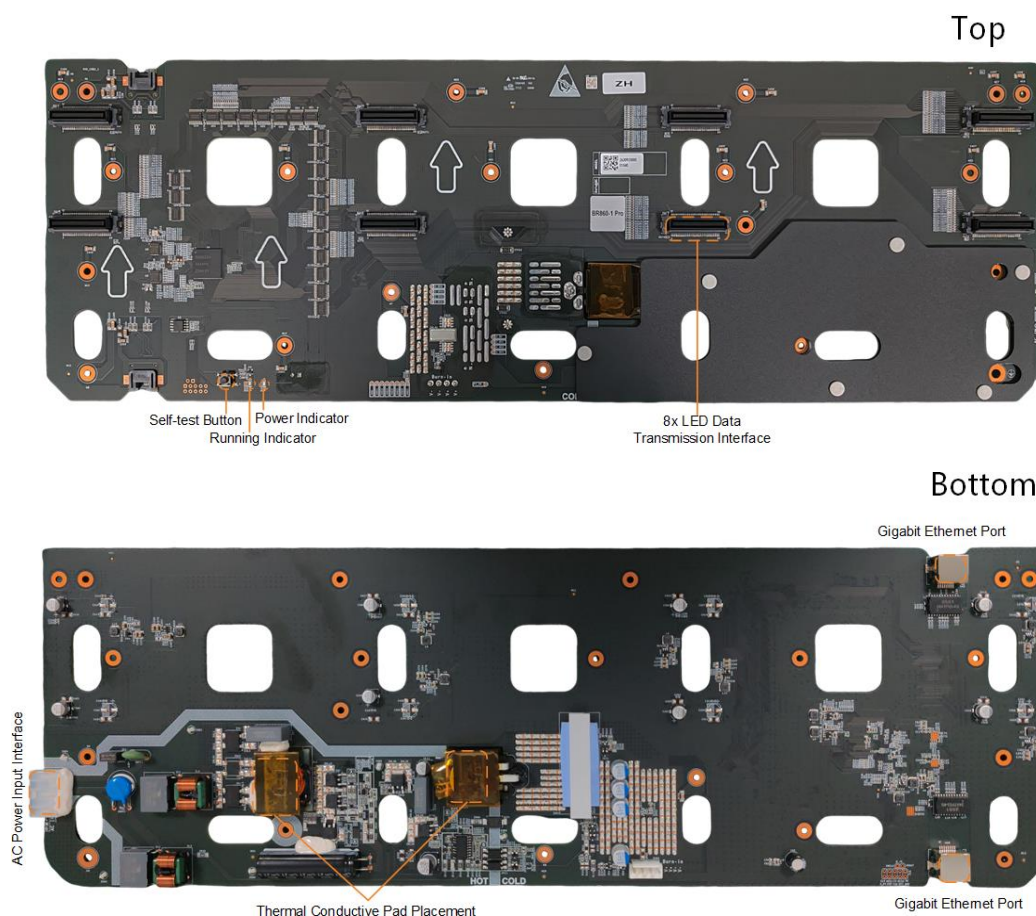
- Dual Backup of Configuration Parameters

The receiving card configuration parameters are stored in both the application area and factory area of the receiving card at the same time. Users usually use the configuration parameters in the application area. If necessary, users can restore the configuration parameters in the factory area to the application area.

- Dual Program Backup

Two copies of the firmware program are stored in the receiving card at the factory to avoid the problem that the receiving card may get stuck abnormally during program update.

Appearance



Product images are for reference only. The actual product may vary.

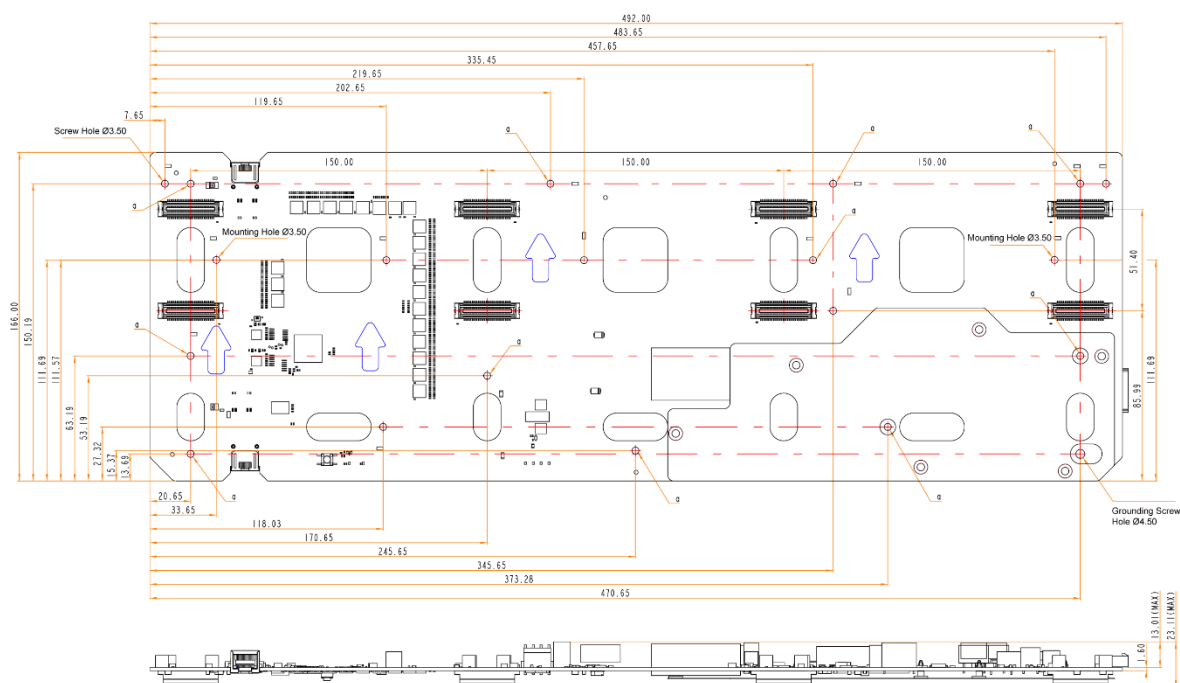
Indicators

Indicators	Color	Status	Description
Running indicator	Green	Flashing once every 1s	The receiving card is functioning normally. Ethernet cable connection is normal, and video source input is available.
		Flashing once every 3s	Ethernet cable connection is abnormal.
		Flashing 3 times every 0.5s	Ethernet cable connection is normal, but video source input is unavailable.
		Flashing once every 0.2s	The receiving card failed to load the program in the application area and is now using the backup program.

Indicators	Color	Status	Description
		Flashing 8 times every 0.5s	A redundancy switchover occurred on the Ethernet port and the loop backup has taken effect.
Power indicator	Red	Always on	The power input is normal.

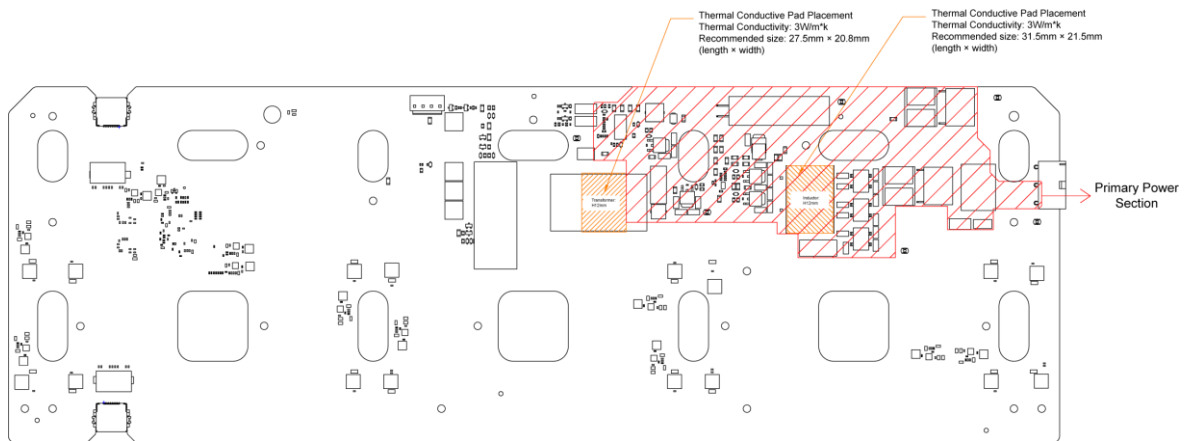
Dimensions

The board thickness is not greater than 2.0 mm, and the total thickness (board thickness + thickness of components on the top and bottom sides) is not greater than 23.1 mm.



 Note

In accordance with the compatibility of three-in-one receiving cards, the spot marked "a" in the diagram is the recommended mounting hole locations. Other mounting hole locations can be adapted based on specific needs.

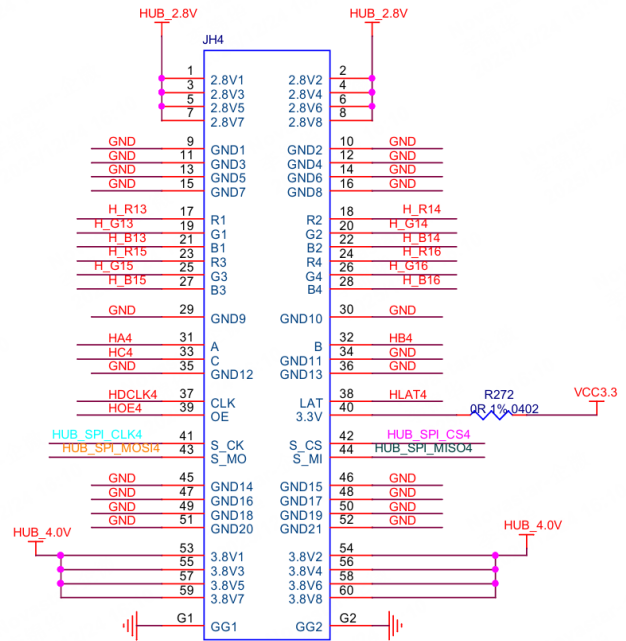
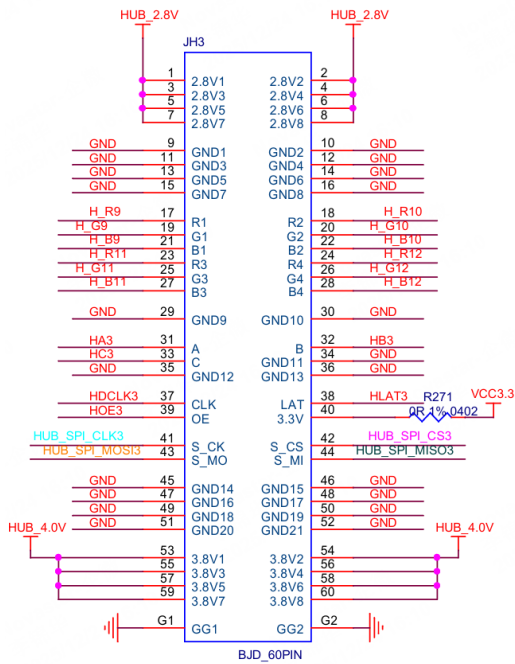
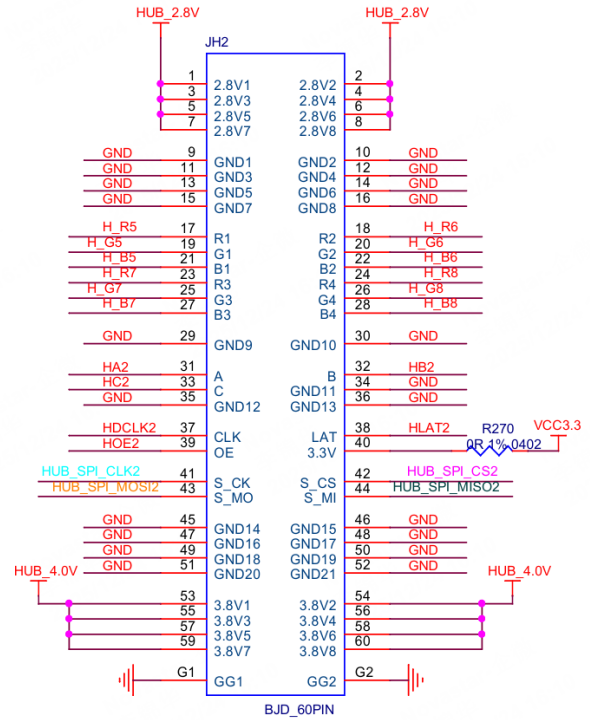
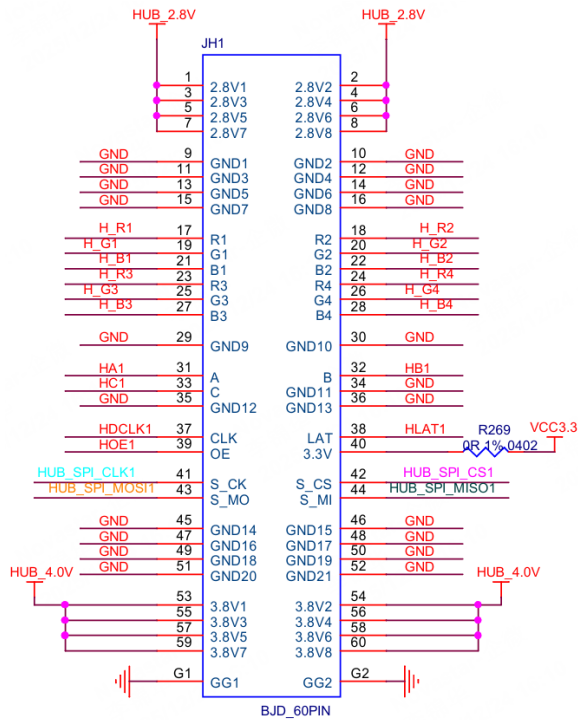


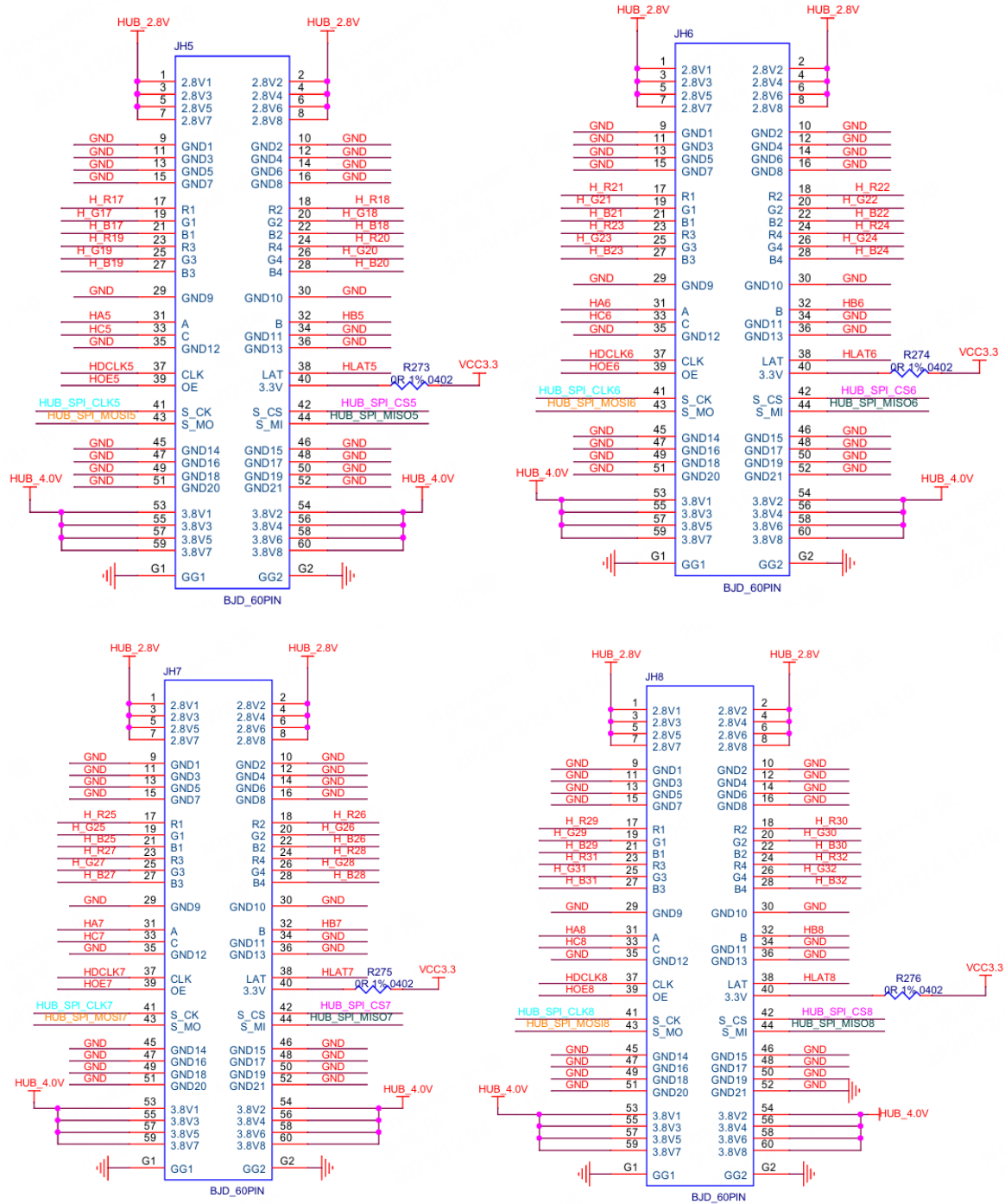
Tolerance: ± 0.3 Unit: mm

Note

- For molding or installation cutouts, please contact NovaStar for a higher-precision structural drawing.
- The thermal conductive pad and silicone insulation pad are not included with the product. You will need to adhere them yourself according to the specified positions and sizes in the diagram. Attach the thermal conductive pad to the card, ensuring the thickness is appropriate for the available space in the cabinet and that it is compressed when in place. The silicone insulation pad should be adhered to the cabinet.
- The red shaded area in the diagram is the primary power section. Ensure a safety distance of at least 5 mm between this area and the metal conductor of the cabinet. If this distance is not met, add a silicone insulation pad for additional insulation. Design the silicone pad to extend more than 5 mm beyond the primary power section.
- For other areas, maintain a safety distance of at least 2 mm from the cabinet.
- The silicone pad should be 0.23 mm thick, with a voltage resistance of ≥ 4 kV AC and a thermal conductivity of ≥ 1.6 W/(m·K).

Pins





Pin Definitions (Taking JH1 as an example)

/	HUB_2.8	1	2	HUB_2.8	/
/	HUB_2.8	3	4	HUB_2.8	/
/	HUB_2.8	5	6	HUB_2.8	/
/	HUB_2.8	7	8	HUB_2.8	/
/	GND	9	10	GND	/

Pin Definitions (Taking JH1 as an example)					
/	GND	11	12	GND	/
/	GND	13	14	GND	/
/	GND	15	16	GND	/
/	H_R1	17	18	H_R2	/
/	H_G1	19	20	H_G2	/
/	H_B1	21	22	H_B2	/
/	H_R3	23	24	H_R4	/
/	H_G3	25	26	H_G4	/
/	H_B3	27	28	H_B4	/
/	GND	29	30	GND	/
Line decoding signal	HA1	31	32	HB1	Line decoding signal
Line decoding signal	HC1	33	34	GND	/
/	GND	35	36	GND	/
Shift clock	HDCLK1	37	38	HLAT1	Latch signal
Display enable signal	HOE1	39	40	VCC3.3	/
Clock signal of serial pin	HUB_SPI_CLK1	41	42	HUB_SPI_CS1	CS signal of serial pin
Module flash data storage input	HUB_SPI_MOSI1	43	44	HUB_SPI_MISO1	Module flash data storage output
/	GND	45	46	GND	/
/	GND	47	48	GND	/
/	GND	49	50	GND	/
/	GND	51	52	GND	/
/	HUB_4.0V	53	54	HUB_4.0V	/
/	HUB_4.0V	55	56	HUB_4.0V	/
/	HUB_4.0V	57	58	HUB_4.0V	/
/	HUB_4.0V	59	60	HUB_4.0V	/
/	GND	G1	G2	GND	/

Electrical Specifications

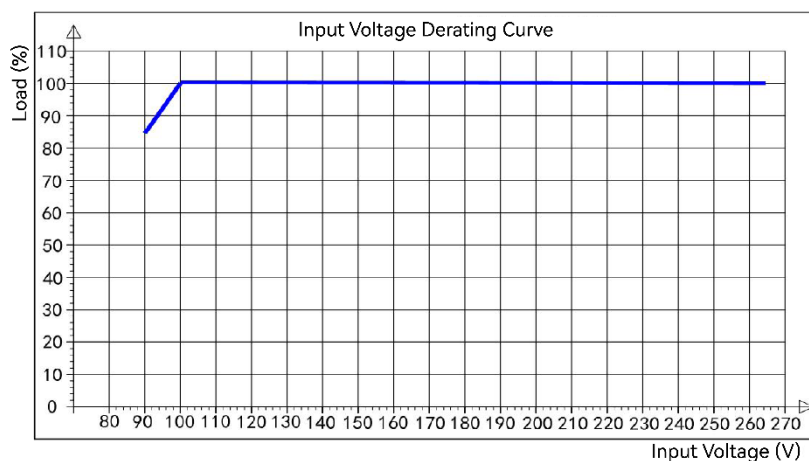
Input Specifications

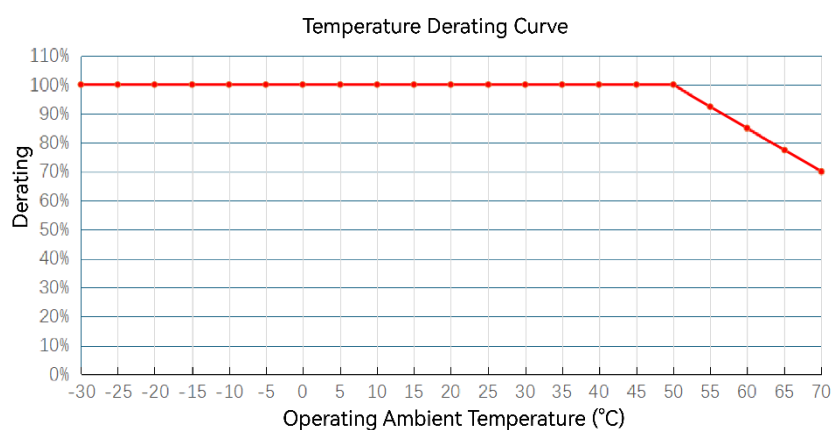
Input Voltage	90 Vac to 264 Vac
Nominal Input	100 Vac to 240 Vac
Frequency Range	47 Hz to 63 Hz
Starting Voltage	> 70 Vac
Maximum Input Current	2.3 A
Inrush Current	Cold start: 100 A at 240 Vac, 50 A at 100 Vac
Power Factor	@ 240 Vac ≥ 0.90 ; @ 100 Vac ≥ 0.97
Current Harmonics	GB17625.1; EN61000-3-2,-3
Standby Power Consumption	≤ 4 W
Input Fuse	T5AL/250Vac

Output Specifications

Output Current	35 A (Rated) 40 A (Maximum) Note: Peak current is tested under the condition that the pulse width is less than 100ms and the ambient temperature is 30°C.
Output Voltage	Main voltage: 4.0 V Low voltage: 2.8 V
Output Voltage Accuracy	$\pm 2.0\%$
Line Regulation	$\pm 2.0\%$
Load Regulation	$\pm 2.0\%$
Output Ripple Noise	≤ 200 mV Note: At a temperature of 25°C, the bandwidth is set to 20 MHz. A 0.1 μ F ceramic capacitor and a 10 μ F electrolytic capacitor are connected in parallel

	at the output for testing purposes.
Temperature Coefficient	Pending
Dynamic Load Performance	0% to 50% load and 50% to 100% load, < 10%
Efficiency	@ 240 Vac, 88%, CH1 36 A @ 100 Vac, 84%, CH1 36 A
Output Voltage Rise Time	30.0ms max Note: Rise time is defined as the time it takes for the output voltage to increase from 10% to 90%. This is tested with a 0.1 μ F ceramic capacitor and a 10 μ F electrolytic capacitor connected in parallel at the output.
Start-up Delay Time	Max 1s at 220 Vac
Hold-up Time	@ 240 Vac, 15ms @ 100 Vac, 10ms
Voltage Overshoot	10% max Note: All DC output currents should range from minimum to maximum values.
Capacitive Load	32,900 μ F
Ratio Radiation Emission	Pending
Switching Frequency	Pending
Power Temperature Derating	-20°C to +70°C (Above 50°C, reduce load by 1.5% for every additional 1°C)
Power Input Voltage Derating	Between 90 Vac and 100 Vac, for every 1 V decrease, reduce load by 1.5%
MTBF	$\geq$ 100,000 hours at 25°C





Protection

Input Undervoltage Protection	Engages above 70 Vac, disengages below 65 Vac
Output Overvoltage Protection	< 6.5 V, self-recovery
Output Overcurrent Protection	Triggered at 1.3 to 1.6 times of rated current
Output Overpower Protection	Triggered at 1.3 to 1.6 times of rated power
Output Short-circuit Protection	Self-recovery

Safety

Insulation Resistance	Input to output 500 Vdc, 100 MΩ min (at room temperature)
Insulation Withstand Voltage	Input to output (I/P-O/P): 3.0 KVac / 10 mA Input to case (I/P-CASE): 1.8 KVac / 10 mA Note: This refers to AC withstand voltage. The DC withstand voltage is 1.414 times the AC withstand voltage, while the leakage current remains the same.
Ground Resistance	< 0.1 Ω
Leakage Current	IEC 62368-1

 Note

If there are lightning protection components in the circuit, the following steps should be taken during the voltage withstand test after disconnecting the air gap tube:

- The input lines (L&N) need to be short-circuited together, and all the output lines need to be short-circuited together.
- Input to output: Input short-circuit line to output short-circuit line test.
- Input to FG: Input short-circuit line to FG.

EMC

Conducted Emission	GB/T9254.1-2021/EN55032/FCC, Class A
Radiated Emission	GB/T9254.1-2021/EN55032/FCC, Class A
Power Fluctuation and Flicker	Pending
Radiated Susceptibility	EN55024; EN61000-4-2, 3, 4, 5, 6, 8, 11
Conducted Susceptibility	EN55024; EN61000-4-2, 3, 4, 5, 6, 8, 11
Surge Susceptibility	GB17626.5/IEC61000-4-5 Performance Criteria: B DM: ± 2 kV, CM: ± 4 kV
EFT Immunity	GB17626.4/IEC61000-4-4 Performance Criteria: B ± 3 kV
ESD Immunity	GB17626.2/IEC61000-4-2 Performance Criteria: B Contact ± 4 kV, Air ± 8 kV
Voltage Fluctuation and Flicker	Pending
Voltage Drop	GB17626.11/IEC61000-4-11 Performance Criteria: B/C

Voltage Drop Requirements:

Voltage Drop	Duration	Performance Criteria
0% U_t	10 ms	B

Voltage Drop	Duration	Performance Criteria
70% Ut	500 ms	C
40% Ut	200 ms	C
0% Ut	5000 ms	C



Caution

It is required to comply with the above-mentioned standards as a whole system.

Specifications

Maximum Resolution	For PWM driver ICs, the maximum load capacity per board is: • 512×512@60Hz (For 8bit video sources) • 512×256@60Hz (For 10bit and 12bit video sources)	
Operating Environment	Temperature	-20°C to +70°C (Above 50°C, reduce load by 1.5% for every additional 1°C)
	Humidity	10% RH to 90% RH, non-condensing
	Altitude	-60m to +5000m Note: For every 100 meters above 2000 meters in altitude, the maximum operating temperature decreases by 0.5°C.
Storage Environment	Temperature	-40°C to +85°C
	Humidity	5% RH to 95% RH, non-condensing
	Altitude	< 5000 m
Physical Specifications	Dimensions	492.0 mm × 166.0 mm × 23.1 mm
	Net weight	434.0 g Note: It is the weight of a single receiving card only.
Packing Information	Packing specifications	An antistatic bag is provided for each board. Each packing box contains 12 boards.
	Packing box	635.0 mm × 595.0 mm × 283.0 mm

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